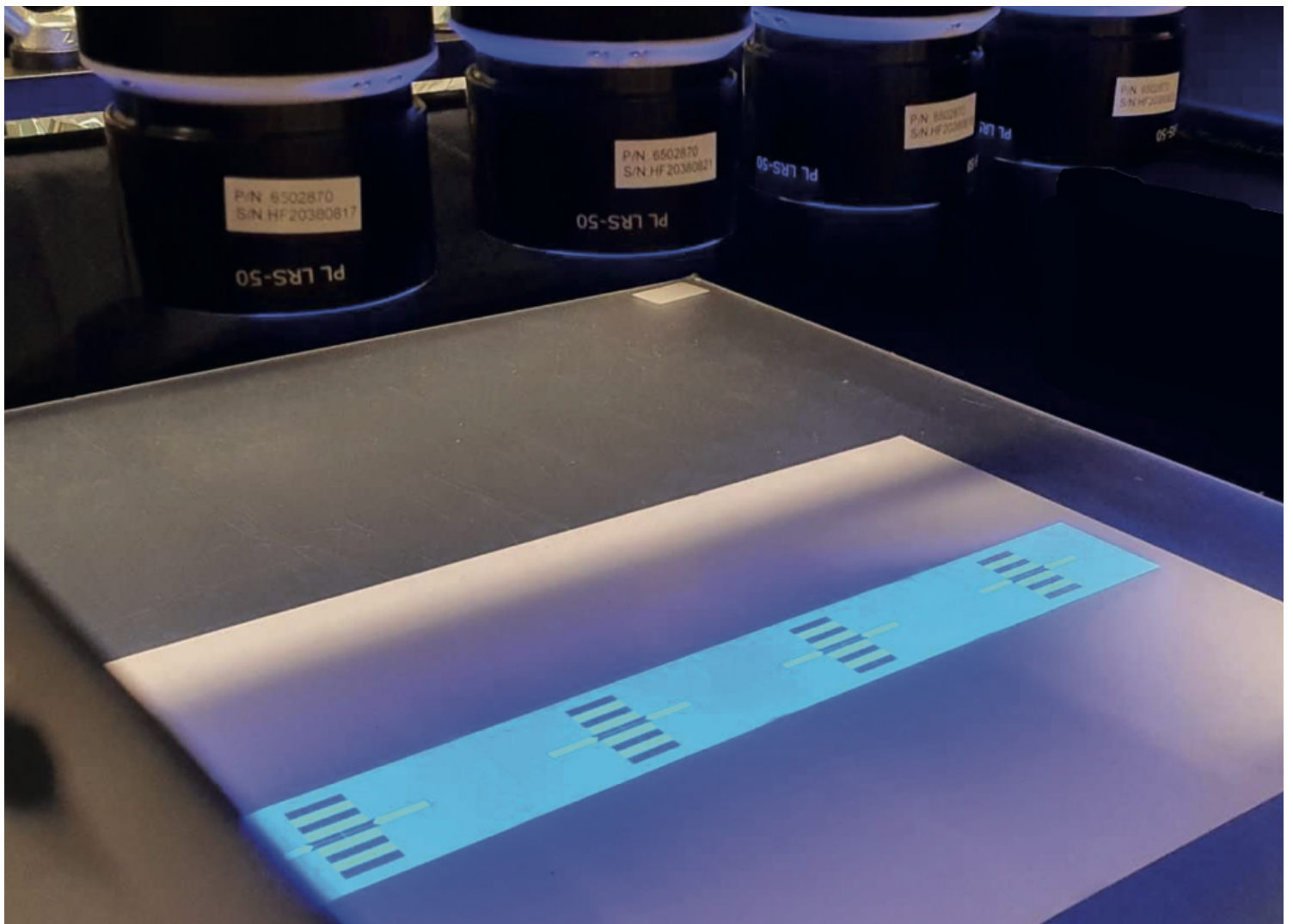


VISITECH SHOWCASING HIGH-VOLUME AM SUBSYSTEM IN ACTION AT AMUG

Posted on March 30, 2022

At AMUG 2022 in Chicago, our US team is on-site to show you our high-volume DLP® stereolithography stacked multi-head subsystem – in action! The system is managed by our integrated LAMA software that supports both stacked and dynamic operation of multiple projectors.



In addition, our team will answer your questions about the all-new high-power micro-SLA (LRS- μ SLA) platform, our groundbreaking Direct Image Sintering (DIS) subsystem using our high-power infrared projector, and our latest high-performance static UV projectors – such as the LRS-4KA and LRS-WQ.

From delicate to ultra-large builds

Our solutions enable machine builders to build machines capable of printing the most delicate 2-micron parts – and scrolling subsystems that allow ultra-large build areas of 1 x 5 m.

20 years of expertise

We look forward to discussing how you can leverage 20 years of industrial lithography and additive manufacturing expertise for your next machine design.

Meet our team at booth 91!

Busy show schedule? **You can book a meeting with us in advance below!**